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(12) **United States Design Patent**
Yamashita et al.

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(54) **HEAT SINK**

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(**) Term: **14 Years**

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(51) **LOC (9) Cl.** **13-03**

(52) **U.S. Cl.** **D13/179**

(58) **Field of Classification Search** D13/179;
165/80.3, 104.33, 151, 122, 185; 257/706,
257/707, 718-722; 361/687, 695, 697, 700,
361/702, 704, 709, 710, 711, 719
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a heat sink, as shown and described.

DESCRIPTION

FIG. 1 is a front elevation view of a heat sink according to our new design;

FIG. 2 is a rear elevation view thereof;

FIG. 3 is a right side elevation view thereof;

FIG. 4 is a left side elevation view thereof;

FIG. 5 is a top plan view thereof;

FIG. 6 is a bottom plan view thereof;

FIG. 7 is a perspective view thereof; and,

FIG. 8 is another perspective view thereof.

The broken lines define portions of the heat sink that form no part of the claimed design.

1 Claim, 8 Drawing Sheets

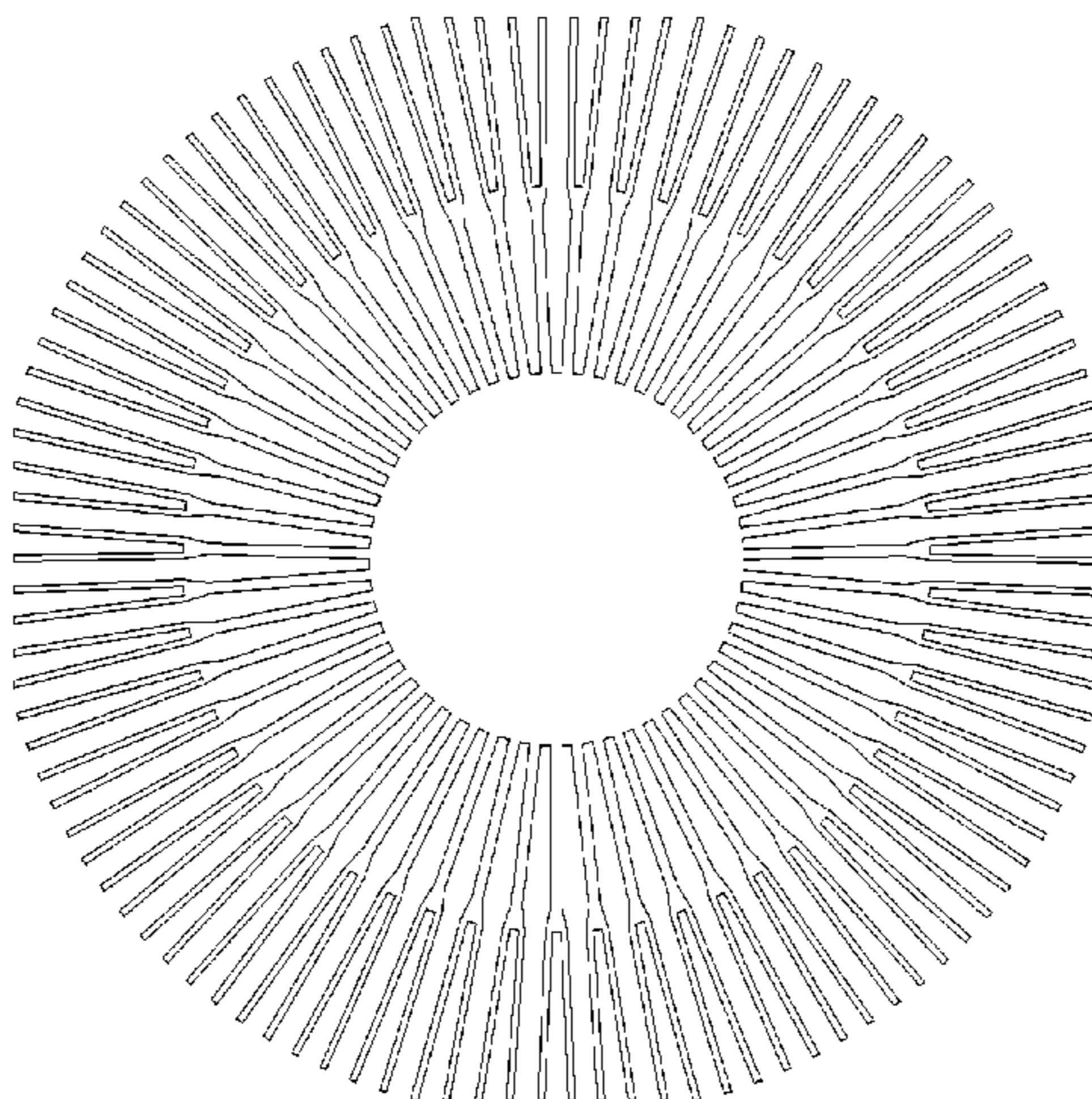


FIG. 1

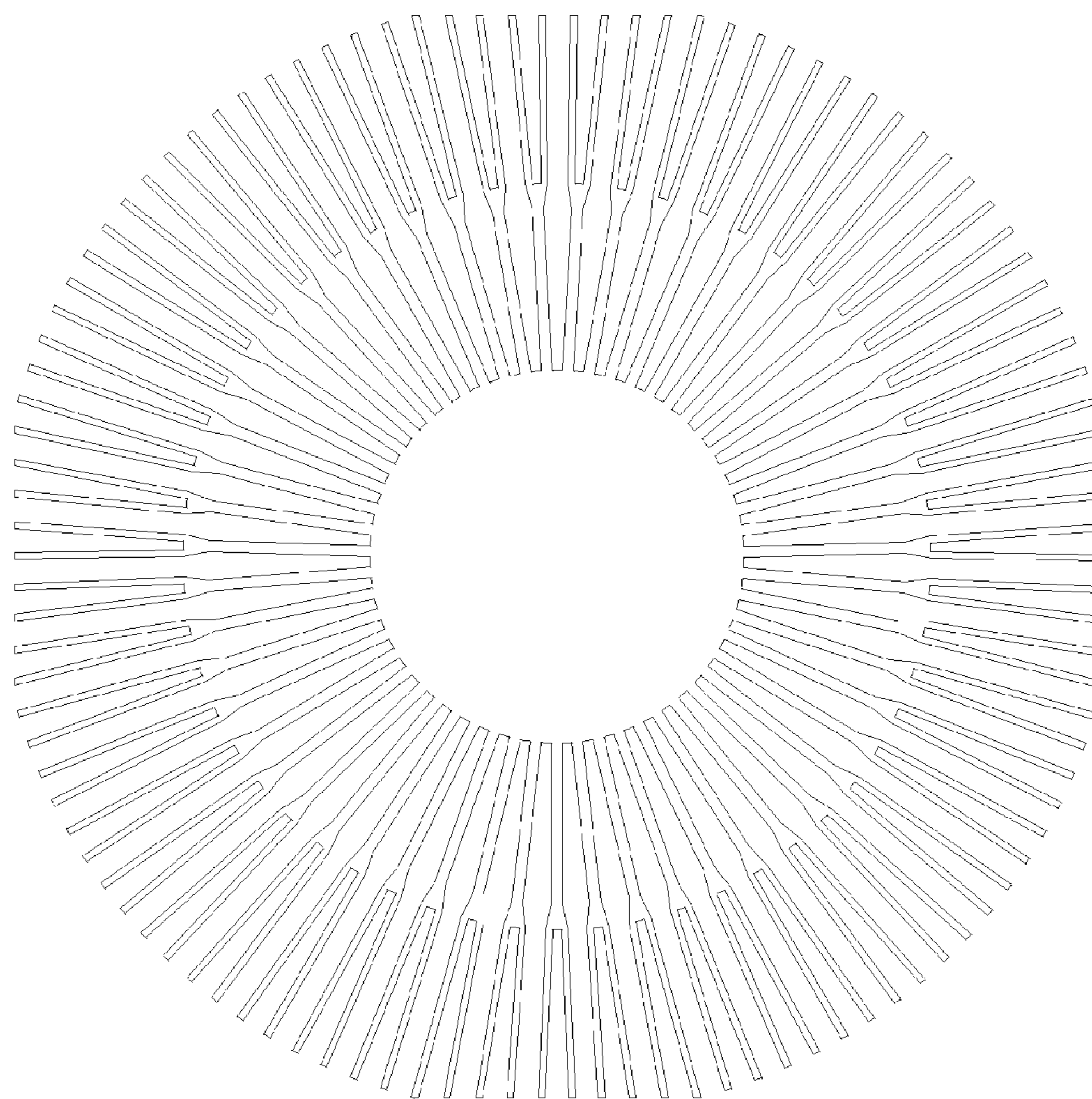


FIG. 2

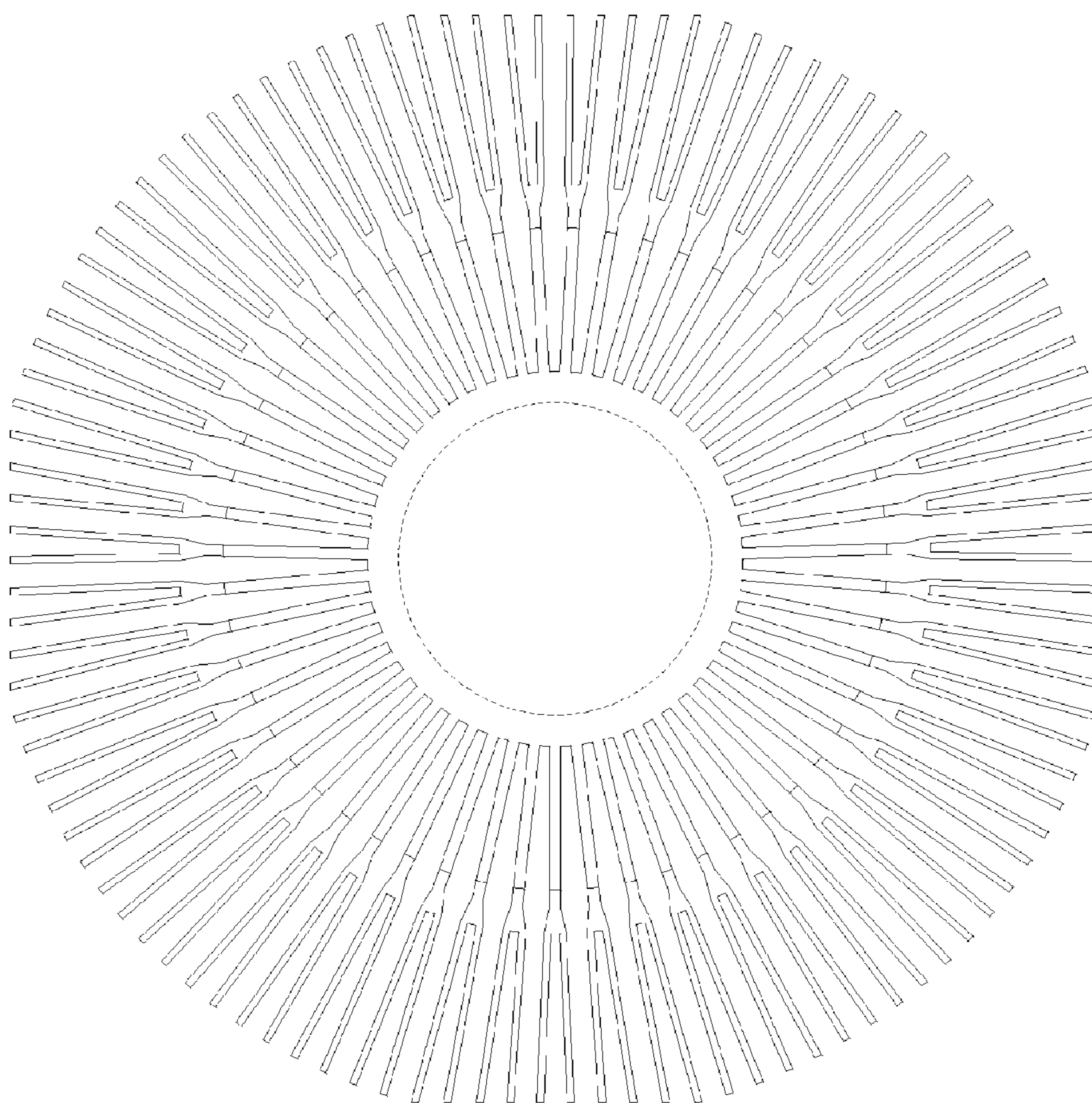


FIG. 3

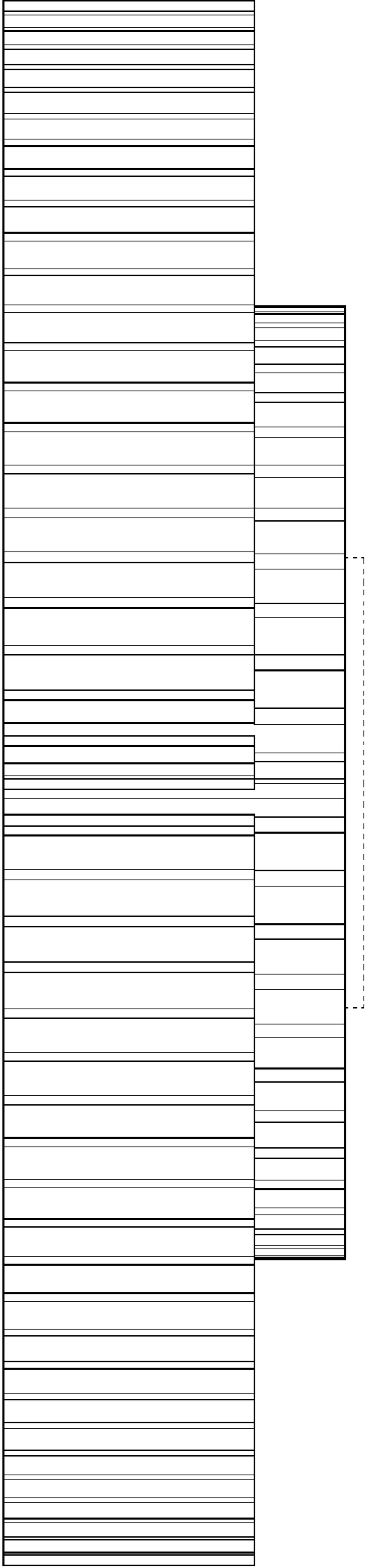


FIG. 4

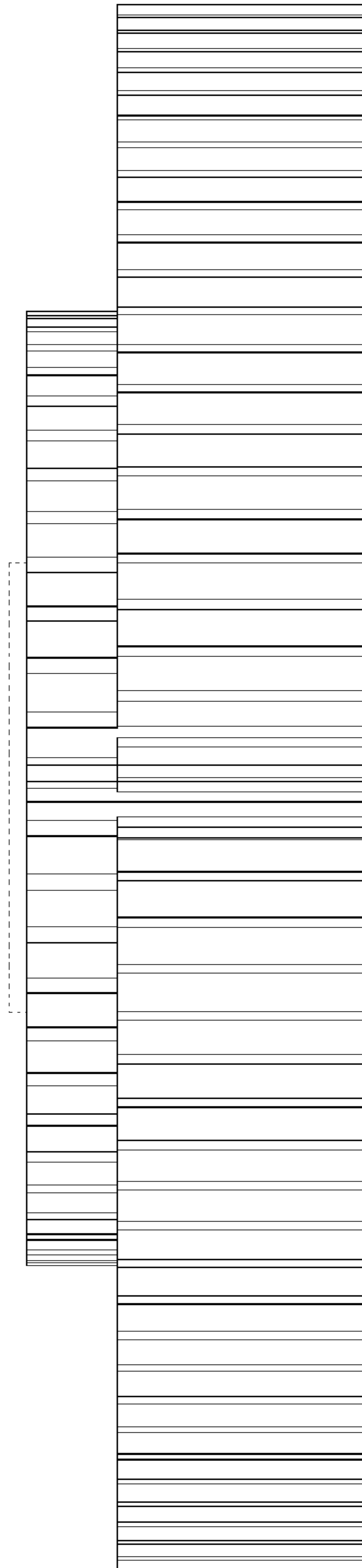


FIG. 5

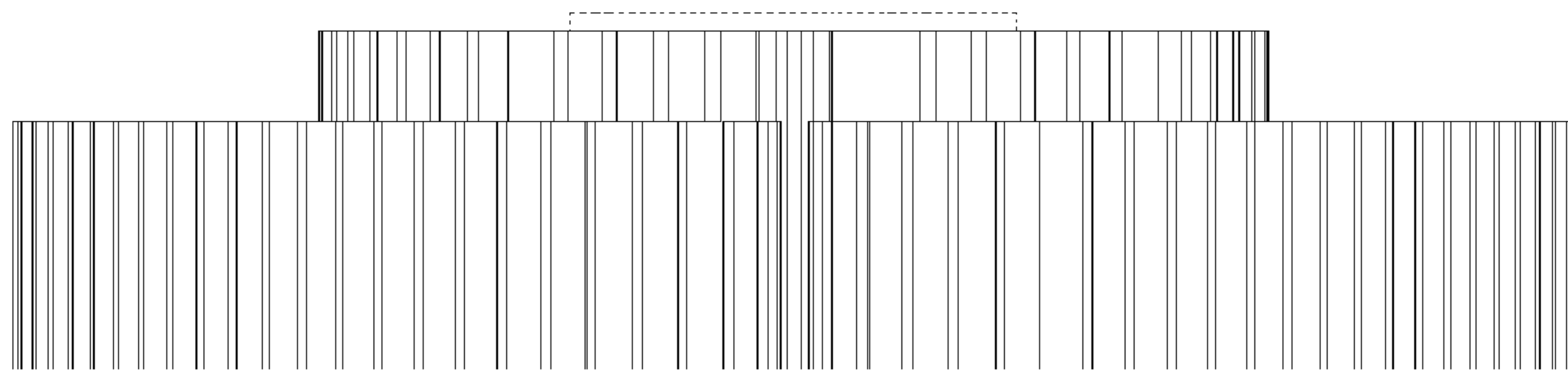


FIG. 6

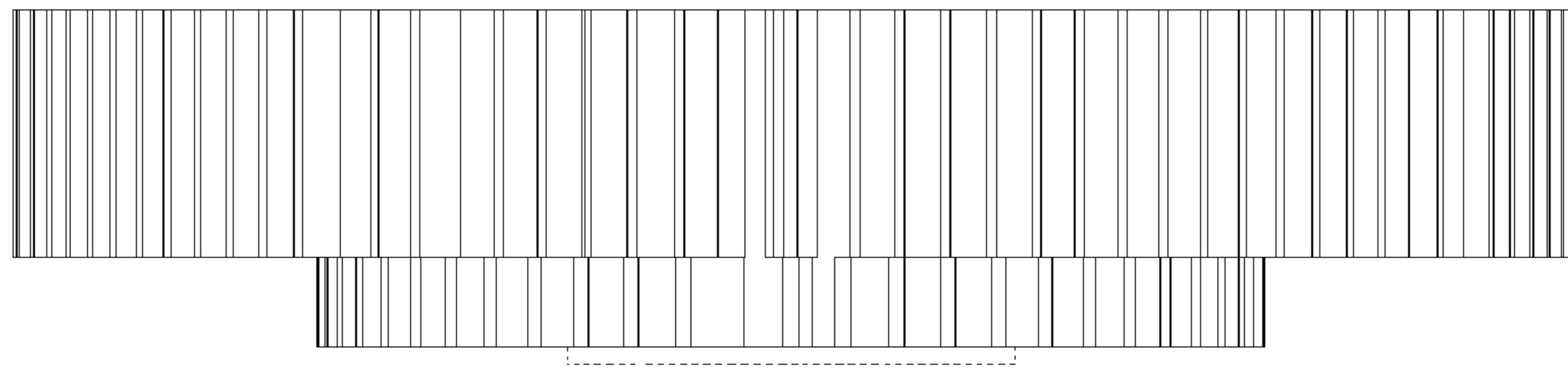


FIG. 7

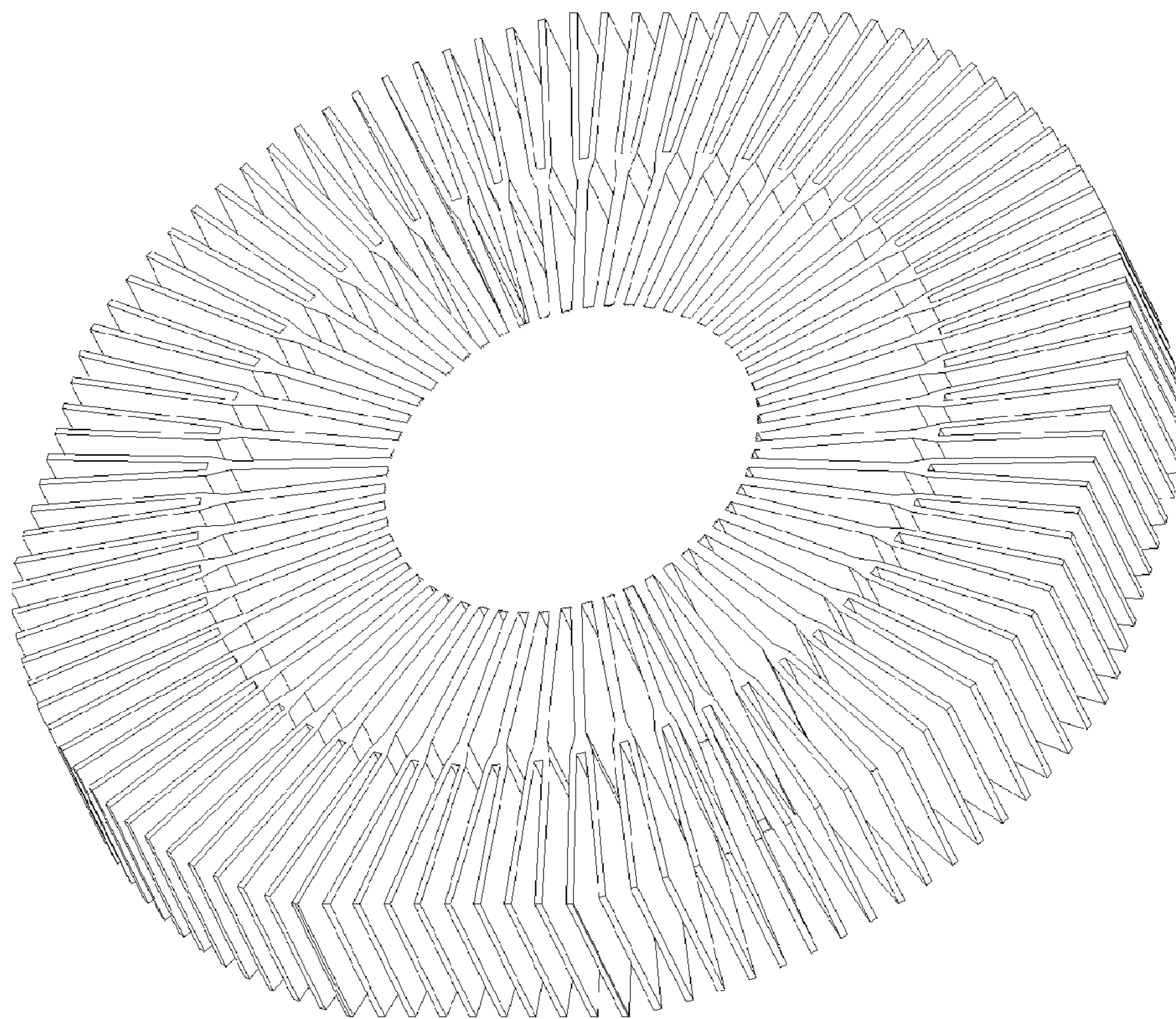


FIG. 8

